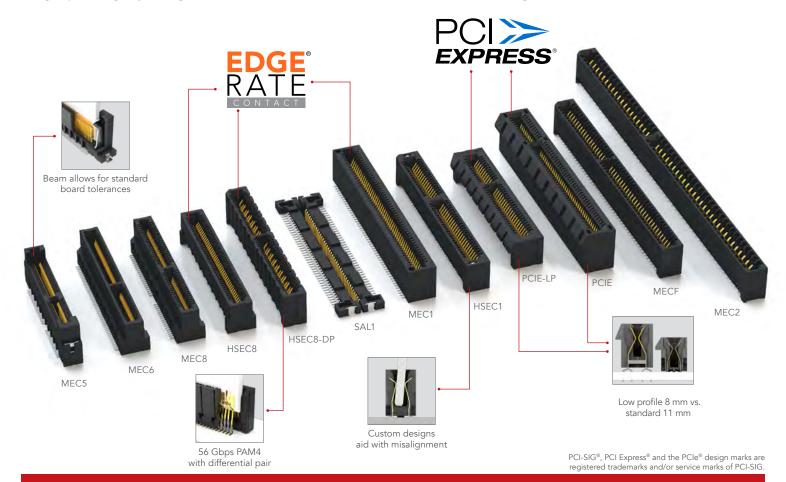


EDGE CARD FLEXIBILITY

HIGH-SPEED, MICRO EDGE CARD SOCKETS

- Maximum design flexibility
- Performance up to 56 Gbps PAM4
- Pitch: 0.50 mm, 0.635 mm, 0.80 mm, 1.00 mm, 1.27 mm, 2.00 mm
- Pin Count: 10 300 total positions
- Orientation: vertical, right-angle, edge mount, pass-through
- Options: power/signal combo, press-fit tails, PCI Express®, rugged weld tabs, locks and latches
- High-speed, high-cycle Edge Rate® contacts (HSEC8, HSEC1)

- Single-ended or differential pairs
- Mates with 1.60 mm (.062") or 2.36 mm (.093") thick cards
- Low profile and elevated body heights
- Custom designs compensate for misalignment (HSEC8-DV, HSEC1-DV)
- Supports PCIe® Gen 4 (MEC5, PCIE-LP)
- High-speed cable mates available (ECDP, PCIEC)
- Meets transmission demands for broadcast video applications, visit samtec.com/12gsdi



System

- MEC5 0.50 mm Pitch Low Cost Sockets
- MEC6 0.635 mm Pitch Micro Sockets
- MEC8 0.80 mm Pitch Micro Sockets
- **HSEC8** 0.80 mm Pitch Edge Rate® Sockets
- SAL1 1.00 mm Pitch Through Board Sockets
- MEC1 1.00 mm Pitch Sockets
- HSEC1 1.00 mm Pitch Edge Rate® Sockets
- PCIE 1.00 mm Pitch PCI Express® Sockets
- MECF 1.27 mm Pitch Sockets
- MEC2 2.00 mm Pitch Sockets

EDGE CARD SOLUTIONS



Justification beam allows for standard PCB tolerance Up to 300 I/Os



Vertical and Right-angle Stagg
Up to 140 I/Os

Staggered press-fit tails available
Up to 140 I/Os



Pass-through, power/signal combo, differential pair options Up to 200 Edge Rate® contacts



Custom designs allow for misalignment mitigation 20 to 140 Edge Rate® contacts



Low-profile version compatible to PCI Express® Gen 4 x1, x4, x8 or x16 lanes



Vertical, right-angle and edge mount

Up to 140 I/Os



MECF

Choice of card thickness and rugged weld tabs

Up to 98 I/Os



MEC₂

Surface mount and through-hole
Up to 98 I/Os



Mounts in pairs for easy signal routing 40 to 80 I/Os per pair